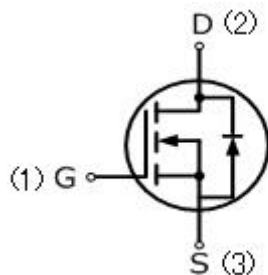


47N60YS

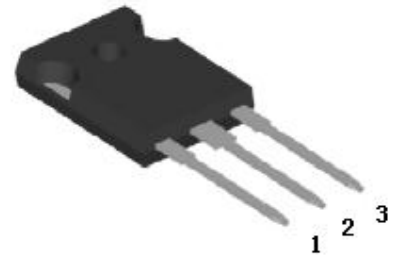
47 Amps, 600 Volts N-Channel Super Junction Power MOSFET

FEATURE

- 47A, 600V, $R_{DS(ON)MAX}=90m\ \Omega$ @ $V_{GS}=10V/15.6A$
- Low gate charge
- Low C_{iss}
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



TO-247



Absolute Maximum Ratings ($T_C=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	47N60YS	UNIT
Drain-Source Voltage	V_{DSS}	600	V
Gate-Source Voltage	V_{GSS}	± 20	
Continuous Drain Current	I_D	47	A
Pulsed Drain Current (Note 1)	I_{DM}	132	
Single Pulse Avalanche Energy (Note 2)	E_{AS}	720	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	T_L	260	$^\circ\text{C}$
Mounting Torque	6-32 or M3 screw	10	lbf • in
		1.1	N • m

Thermal Characteristics

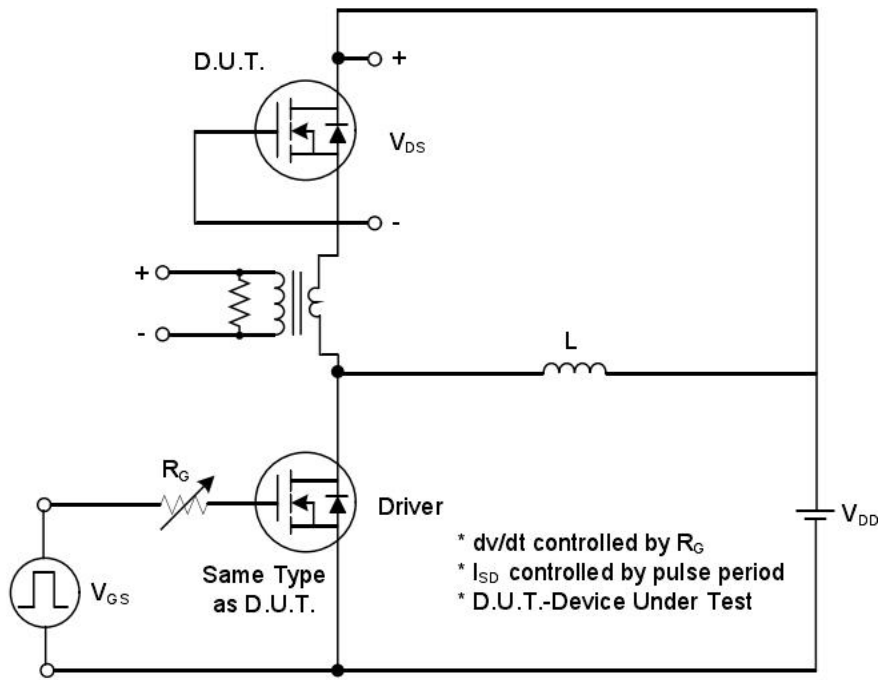
Parameter	Symbol	47N60YS	Units
Maximum Junction-to-Case	R_{thJC}	0.68	$^\circ\text{C}/\text{W}$
Maximum Power Dissipation	P_D	183	W

Electrical Characteristics ($T_c=25^\circ\text{C}$, unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A, T_C=25^\circ\text{C}$	600	—	—	V
		$V_{GS}=0V, I_D=250\mu A, T_C=125^\circ\text{C}$	—	700	—	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=600V, V_{GS}=0V$	—	—	1	μA
Gate-Body Leakage Current, Forward	I_{GSSF}	$V_{GS}=20V, V_{DS}=0V$	—	—	100	nA
Gate-Body Leakage Current, Reverse	I_{GSSR}	$V_{GS}=-20V, V_{DS}=0V$	—	—	-100	nA
On Characteristics						
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	—	4	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=15.6A$	—	68	90	m Ω
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS}=25V, V_{GS}=0V,$ $f=1.0\text{MHz}$	—	3112	—	pF
Output Capacitance	C_{oss}		—	2399	—	pF
Reverse Transfer Capacitance	C_{rss}		—	62	—	pF
Switching Characteristics						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=300V, I_D=20A,$ $R_G=25\Omega$ (Note3,4)	—	45.5	—	ns
Turn-On Rise Time	t_r		—	120.6	—	ns
Turn-Off Delay Time	$t_{d(off)}$		—	137	—	ns
Turn-Off Fall Time	t_f		—	116.2	—	ns
Total Gate Charge	Q_g	$V_{DS}=480V, I_D=20A,$ $V_{GS}=10V,$ (Note3,4)	—	88	—	nC
Gate-Source Charge	Q_{gs}		—	21.7	—	nC
Gate-Drain Charge	Q_{gd}		—	41	—	nC
Drain-Source Body Diode Characteristics and Maximum Ratings						
Continuous Diode Forward Current	I_S		—	—	47	A
Pulsed Diode Forward Current	I_{SM}		—	—	132	A
Diode Forward Voltage	V_{SD}	$I_S=20A, V_{GS}=0V$	—	—	1.5	V
Reverse Recovery Time	t_{rr}	$V_{GS}=0V, I_S=20A,$ $dI_F/dt=100A/\mu s,$ (Note3)	—	947.1	—	ns
Reverse Recovery Charge	Q_{rr}		—	6.8	—	μC

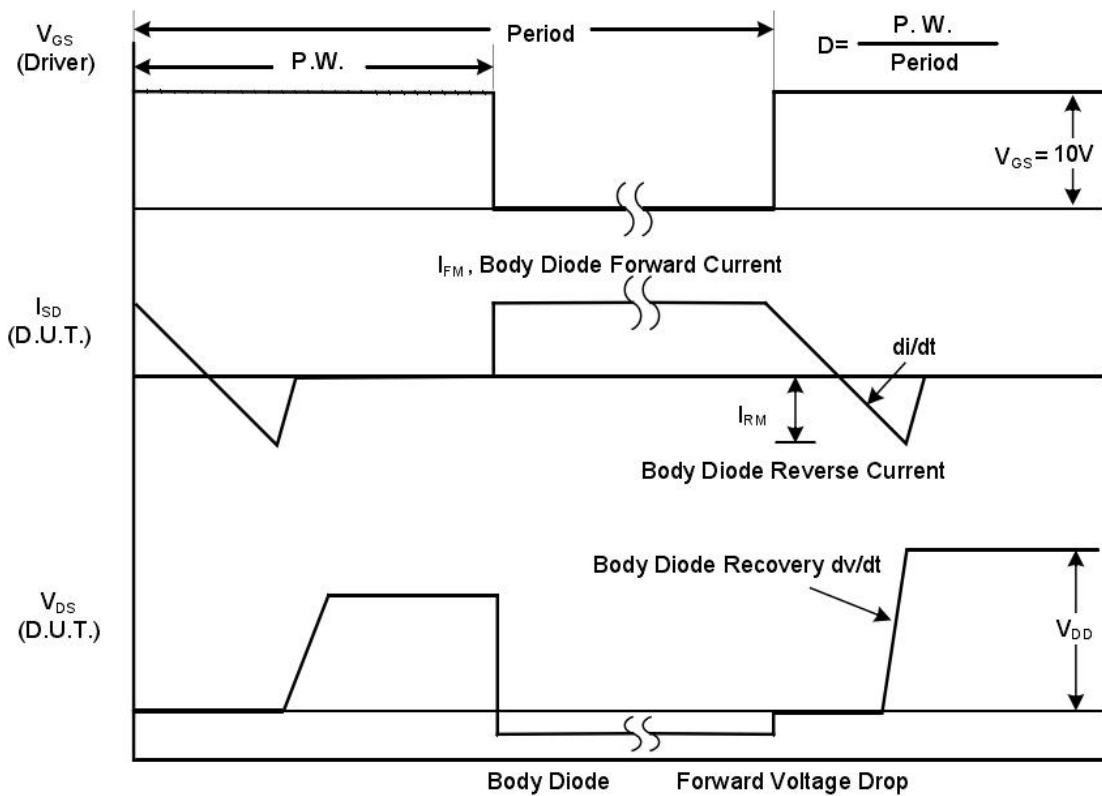
Notes

1. Repetitive Rating: pulse width limited by maximum junction temperature.
2. $L=10\text{mH}, R_g=25\Omega, I_{AS}=12A,$ starting $T_J=25^\circ\text{C}$.
3. $dI/dt=200A/\mu s,$ starting $T_J=25^\circ\text{C}$. Pulse width $\leq 300\mu s$; duty cycle $\leq 2\%$.
4. Repetitive rating; pulse width limited by maximum junction temperature.

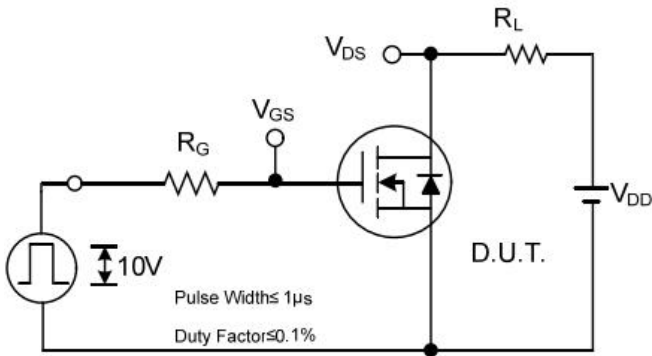
TEST CIRCUIT AND WAVEFORM



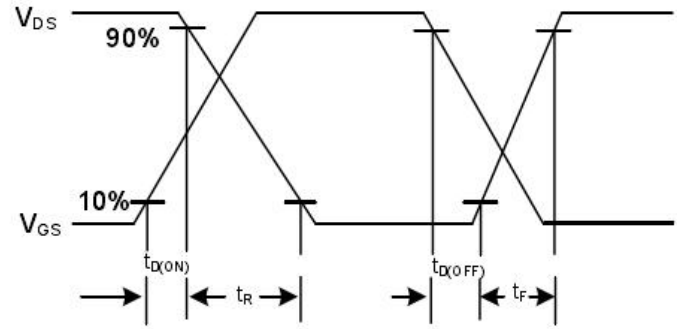
Peak Diode Recovery dv/dt Test Circuit



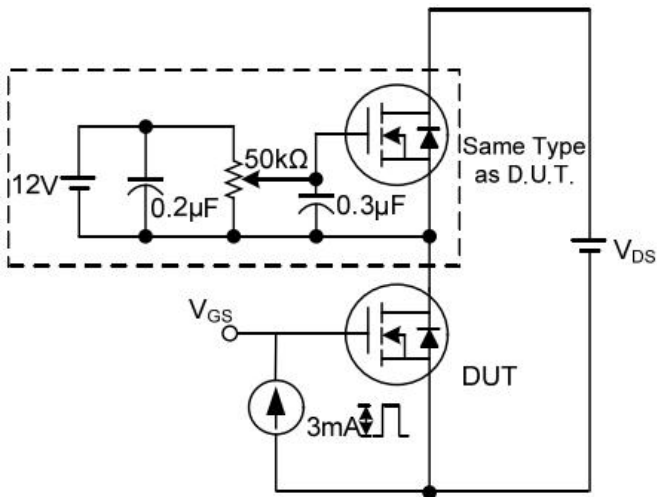
Peak Diode Recovery dv/dt Waveforms



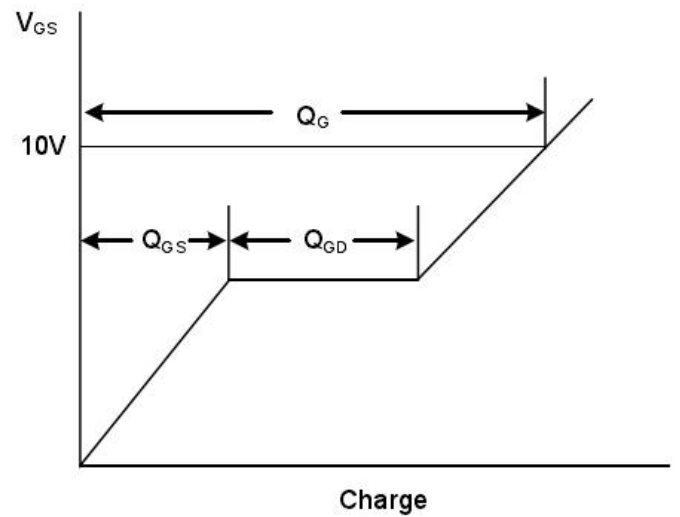
Switching Test Circuit



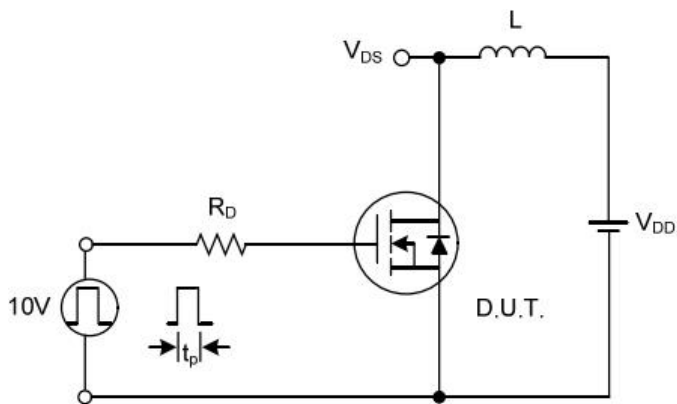
Switching Waveforms



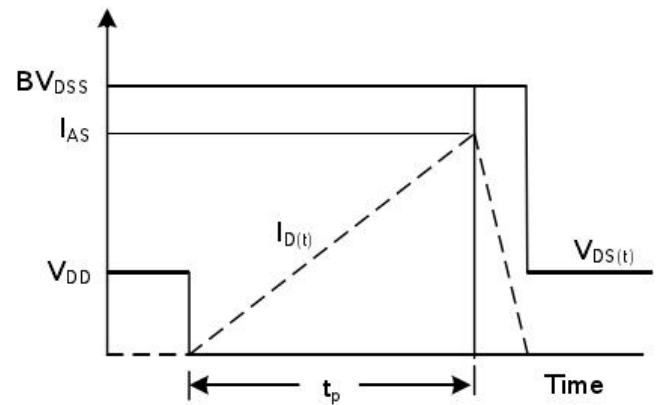
Gate Charge Test Circuit



Gate Charge Waveform

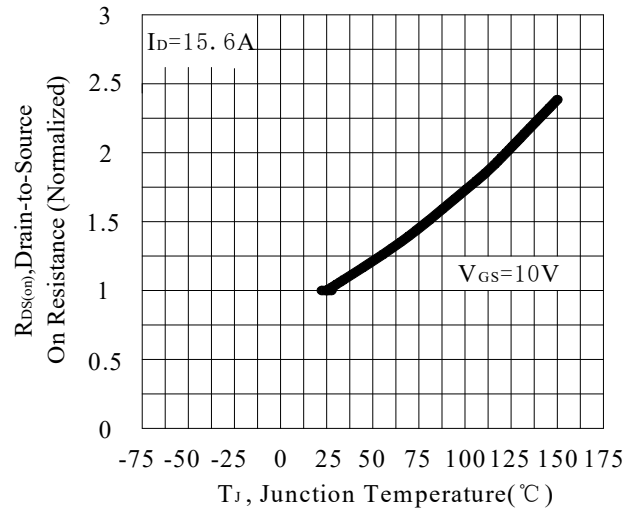
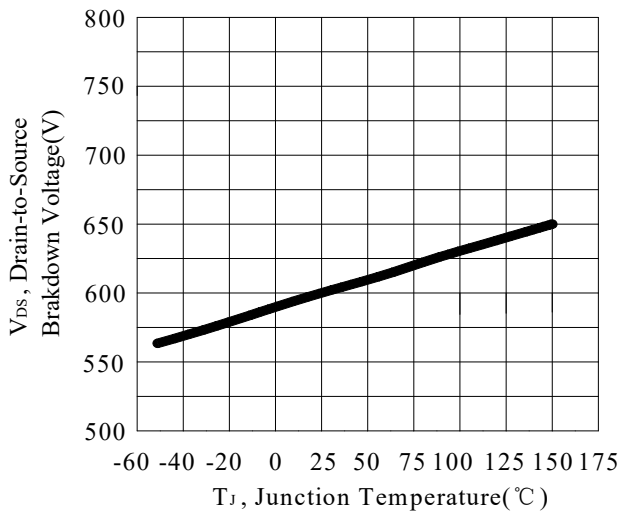
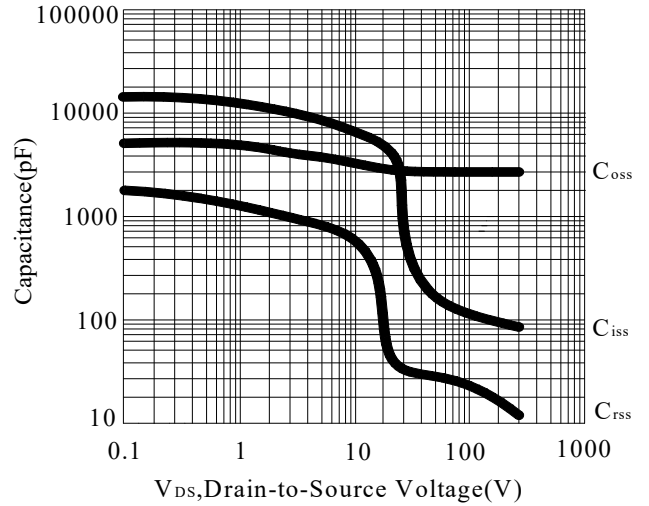
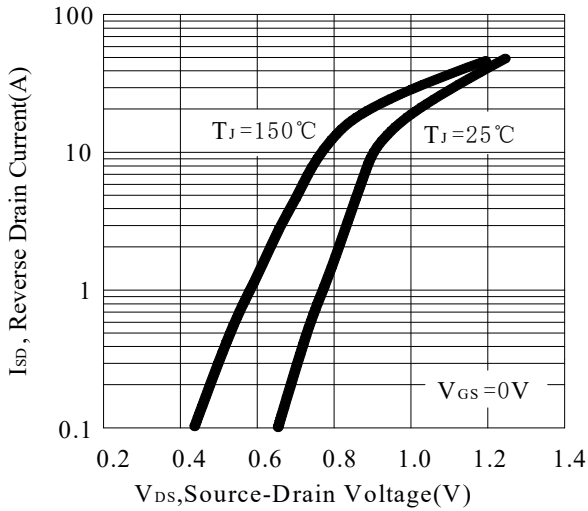
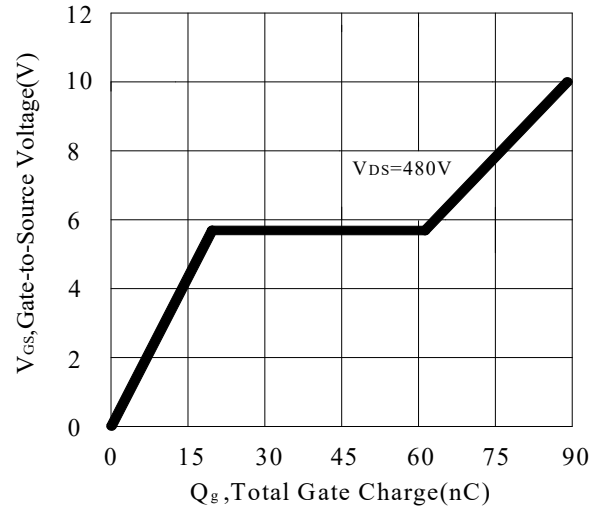
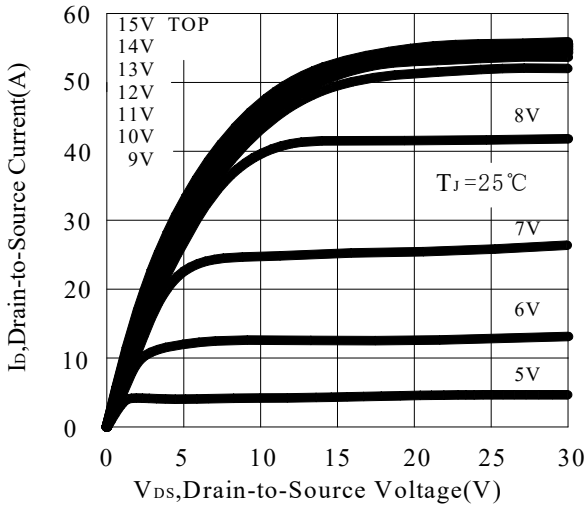


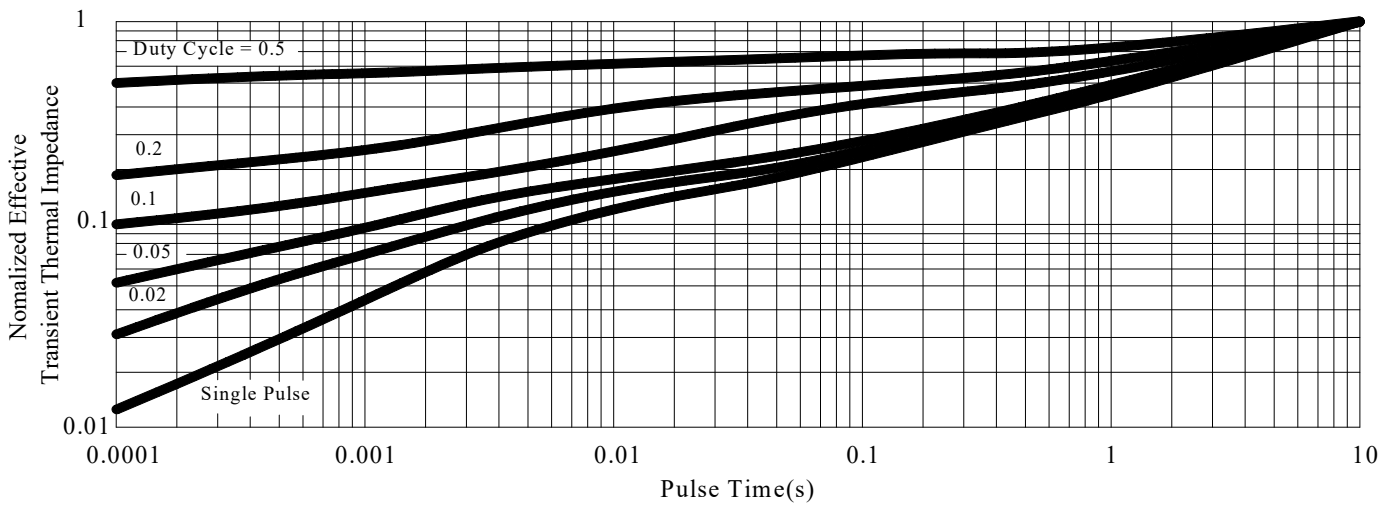
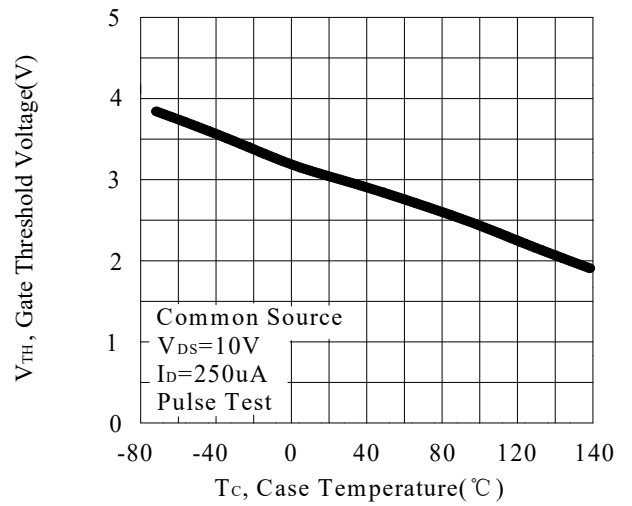
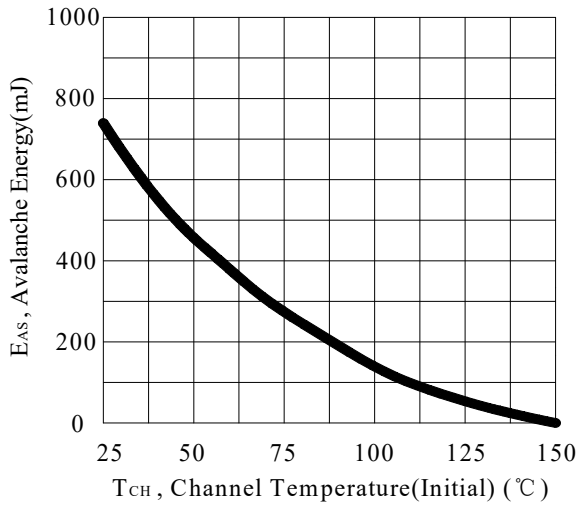
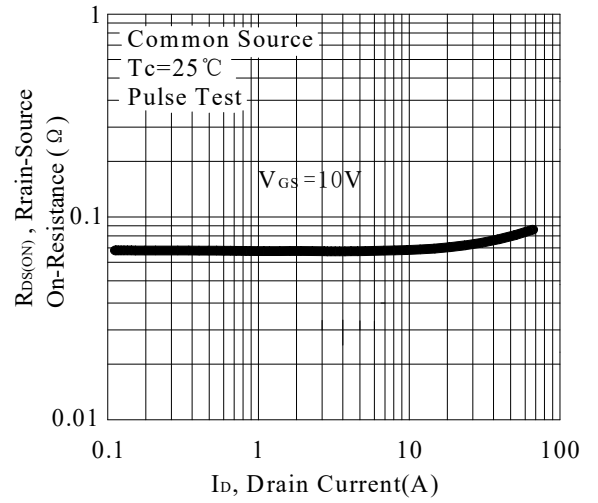
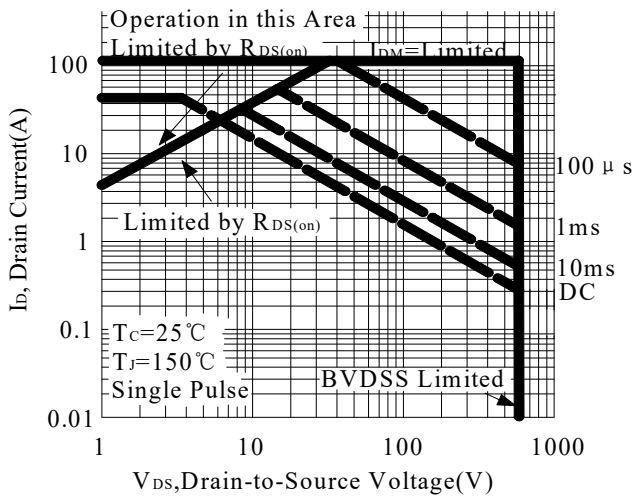
Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

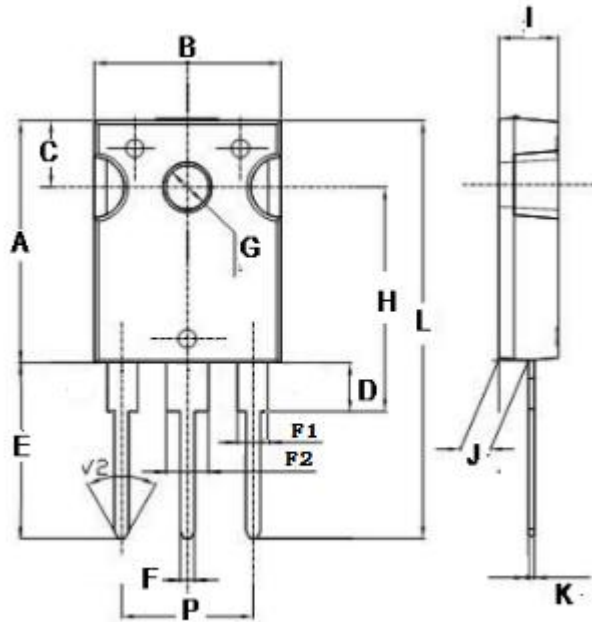
RATING AND CHARACTERISTIC CURVES





PACKAGE OUTLINE DIMENSIONS

TO-247



Dim	Min	Max
A	20.0	22.0
B	15.5	16.0
C	5.7	6.3
D	4.0	4.4
E	19.0	21.0
F	1.1	1.3
G	3.5	3.8
H	18.3	20.2
I	4.9	5.2
J	2.3	2.5
K	0.55	0.65
L	39.0	42.0
P	10.7	10.9
F1	1.9	2.1
F2	2.9	3.1
mm		